



TIGER ELECTRONIC CO.,LTD

SK32 THRU SK310

Features

- Lead Free Finish/Rohs Compliant (Note1) ("P" Suffix designates Compliant. See ordering information)
- For Surface Mount Applications
- High Current Capability With Low Forward Voltage
- High Temp Soldering: 260°C for 10 Seconds At Terminals
- Epoxy meets UL 94 V-0 flammability rating
- Moisture Sensitivity Level 1

Maximum Ratings

- Operating Temperature: -55°C to +150°C
- Storage Temperature: -55°C to +150°C
- Maximum Thermal Resistance :10°C/W Junction To Lead
- Maximum Thermal Resistance :55°C/W Junction To Ambient

MCC Catalog Number	Device Marking	Maximum Recurrent Peak Reverse Voltage	Maximum RMS Voltage	Maximum DC Blocking Voltage
SK32	SK32	20V	14V	20V
SK33	SK33	30V	21V	30V
SK34	SK34	40V	28V	40V
SK35	SK35	50V	35V	50V
SK36	SK36	60V	42V	60V
SK38	SK38	80V	56V	80V
SK310	SK310	100V	70V	100V

Electrical Characteristics @ 25°C Unless Otherwise Specified

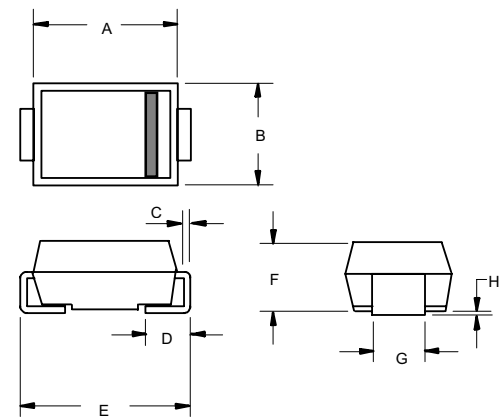
Average Forward Current	$I_{F(AV)}$	3.0A	$T_L = 100^\circ\text{C}$
Peak Forward Surge Current	I_{FSM}	100A	8.3ms, half sine
Maximum Instantaneous Forward Voltage	V_F	.50V .75V .85V	$I_{FM} = 3.0A;$ $T_J = 25^\circ\text{C}^*$
Maximum DC Reverse Current At Rated DC Blocking Voltage	I_R	.5mA 20mA	$T_J = 25^\circ\text{C}$ $T_J = 100^\circ\text{C}$
Typical Junction Capacitance	C_J	250pF	Measured at 1.0MHz, $V_R=4.0V$

*Pulse test: Pulse width 200 μsec , Duty cycle 2%

Note: 1. High Temperature Solder Exemptions Applied, see EU Directive Annex 7.

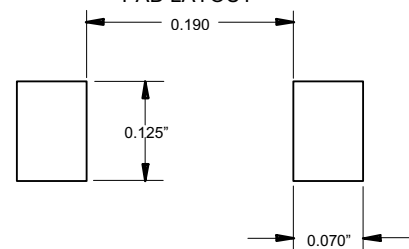
3 Amp Schottky Rectifier 20 to 100 Volts

DO-214AB (SMC) (LEAD FRAME)



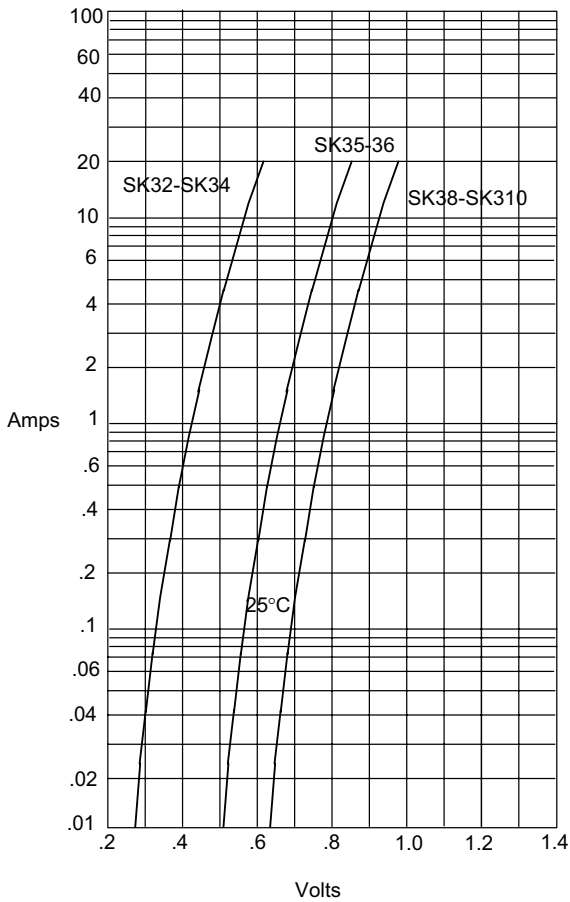
DIM	DIMENSIONS				NOTE
	INCHES		MM		
	MIN	MAX	MIN	MAX	
A	.260	.280	6.60	7.11	
B	.220	.245	5.59	6.22	
C	.006	.012	0.15	0.31	
D	.030	.060	0.76	1.52	
E	.305	.320	7.75	8.13	
F	.079	.103	2.00	2.62	
G	.108	.128	2.75	3.25	
H	.002	.008	0.050	0.203	

SUGGESTED SOLDER PAD LAYOUT



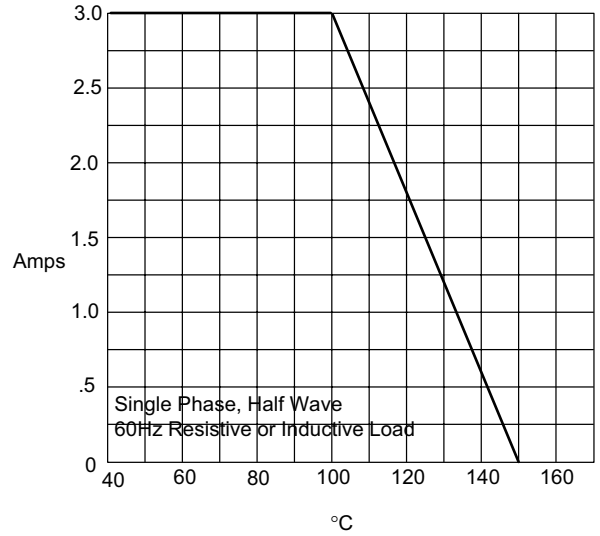
SK32 thru SK310

Figure 1
Typical Forward Characteristics



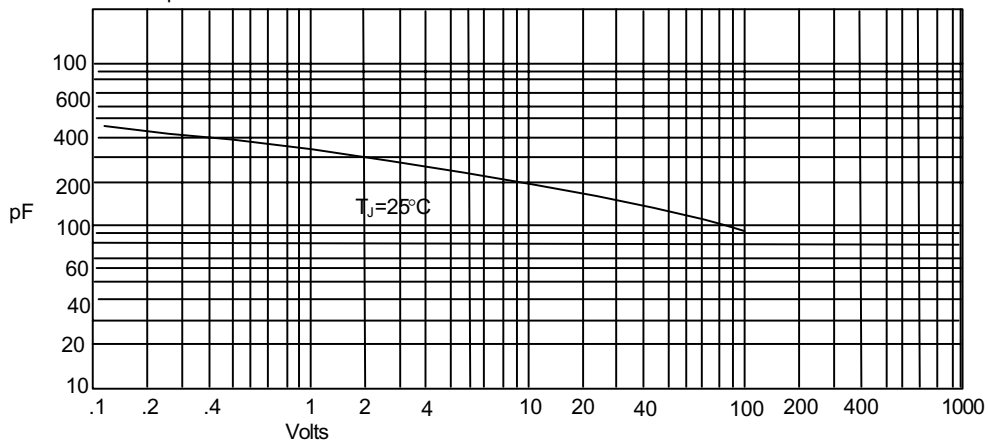
Instantaneous Forward Current - Amperes versus
Instantaneous Forward Voltage - Volts

Figure 2
Forward Derating Curve



Average Forward Rectified Current - Amperes versus
Lead Temperature - °C

Figure 3
Junction Capacitance



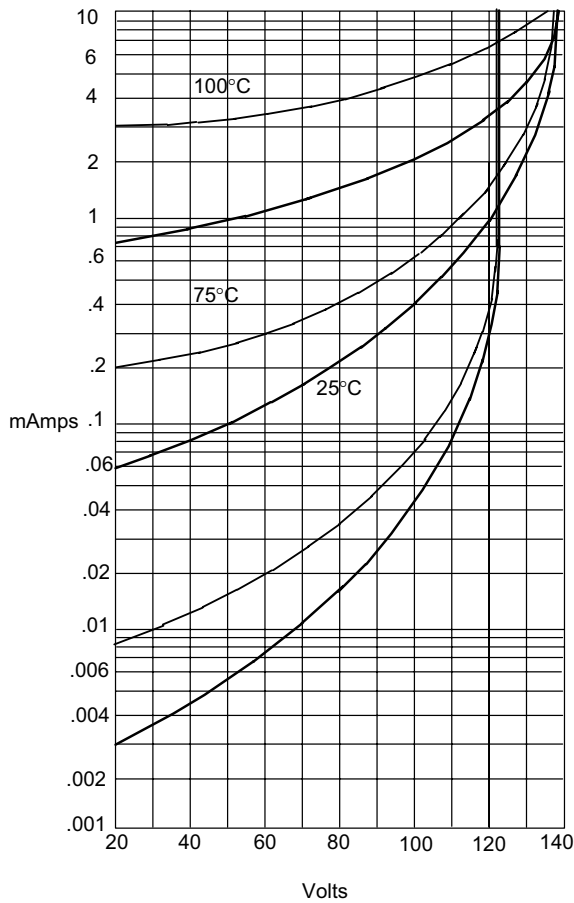
Junction Capacitance - pF versus
Reverse Voltage - Volts

SK32 thru SK310

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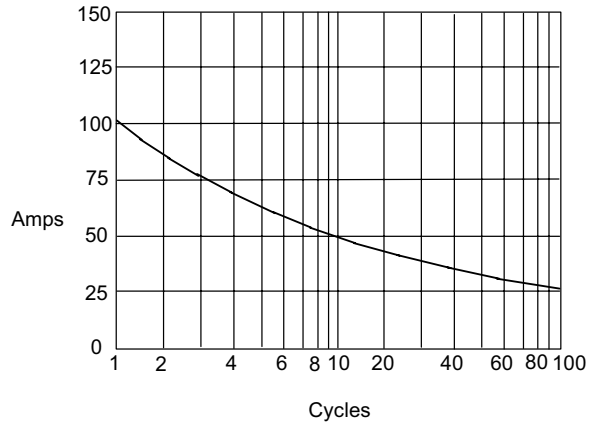
Micro Commercial Components

Figure 4
Typical Reverse Characteristics



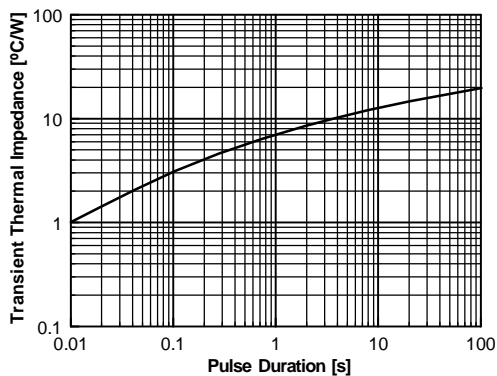
Instantaneous Reverse Leakage Current - MicroAmperes versus
Percent Of Rated Peak Reverse Voltage - Volts

Figure 5
Peak Forward Surge Current



Peak Forward Surge Current - Amperes versus
Number Of Cycles At 60Hz - Cycles

Figure 6
Thermal Impedance Characteristics



Ordering Information :

Device	Packing
Part Number-TP	Tape&Reel: 3Kpcs/Reel

*****IMPORTANT NOTICE*****